WHAT IS CLAIMED IS:

A method for producing an electron-emitting device comprising an electroconductive film having an electron-emitting region between electrodes, wherein a step of forming said electron-emitting region in the electroconductive film comprises a step of heating the electroconductive film and a step of energizing the electroconductive film, in an atmosphere in which a gas for promoting cohesion of the electroconductive film exists.

2. A method for producing an electron-emitting device comprising an electroconductive film having an electron-emitting region between electrodes, wherein a step of forming said electron-emitting region in the electroconductive film comprises a step of energizing the electroconductive film while heating the electroconductive film, in an atmosphere in which a gas for promoting cohesion of the electroconductive film exists.

3. The method according to Claim 1 or 2, wherein the gas for promoting the cohesion of the electroconductive film is a reducing gas.

4. The method according to Claim 1 or 2, wherein the gas for promoting the cohesion of the

5

15

20

í, fi

25

electroconductive filth is either one selected from H_2 , CO, and CH4.

5. The method according to Claim 1 or 2, wherein the gas for promoting the cohesion of the 5 electroconductive film is H_2 .

() The first state of the state of 10

The method according to Claim 1 or 2, wherein heating of said electroconductive film is effected by heating a substrate on which the electroconductive film is placed.

15

The method according to Claim 6, wherein the heating of the substrate is carried out at a temperature not more than 100 °C.

The method according to Claim 6, wherein the heating of said substrate is carried out at a temperature in the range of 50 °C to 100 °C.

20

The method according to Claim 1 or 2, wherein 9. said electroconductive film is an electroconductive film formed through a step of dispensing a droplet containing a metallic compound onto a substrate.

25

10. The method according to Claim 9, wherein the dispensing of the droplet onto the substrate is carried out by an ink jet method.

e3

- 11. The method according to Claim 1 or 2, wherein said electroconductive film is an electroconductive film comprising a metallic oxide as a matrix.
- 12. The method according to Claim 11, wherein said metallic oxide is palladium oxide.

10

13

13. The method according to Claim 1 or 2, wherein said electron-emitting device is a surface conduction electron-emitting device.

15

having a plurality of electron-emitting devices, wherein said electron-emitting devices are produced by either one selected from the methods as set forth in Claims 1 to 13.

20

25

apparatus comprising an electron source having a plurality of electron-emitting devices and an image-forming member for forming an image under irradiation of electrons from the electron source, wherein said electron-emitting devices are produced by either one claim local selected from the methods as set forth in Claims 1 to

13.

AND THE RESIDENCE OF THE PARTY OF THE PARTY

add Di

add 6,3